Notice of Allowability	Application No.	Applicant(s)
	10/013,084	DAUTARTAS ET AL.
	Examiner 040	Art Unit
	Daniel J Petkovsek	2874
The MAILING DATE of this communication apperall claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RI	(OR REMAINS) CLOSED in this app or other appropriate communication IGHTS. This application is subject to	olication. If not included will be mailed in due course. <b>THIS</b>
1. $igotimes$ This communication is responsive to <u>supplemental amenda</u>	ment received October 18, 2004.	
2. ⊠ The allowed claim(s) is/are <u>1-8, and 10-29</u> .		
3. 🔀 The drawings filed on <u>February 2, 2004</u> are accepted by the Examiner.		
<ul> <li>4. ☐ Acknowledgment is made of a claim for foreign priority una) ☐ All b) ☐ Some* c) ☐ None of the:</li> <li>1. ☐ Certified copies of the priority documents have</li> <li>2. ☐ Certified copies of the priority documents have</li> <li>3. ☐ Copies of the certified copies of the priority documents have</li> <li>International Bureau (PCT Rule 17.2(a)).</li> <li>* Certified copies not received:</li> </ul>	been received. been received in Application No	
Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONM THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		complying with the requirements
<ol> <li>A SUBSTITUTE OATH OR DECLARATION must be subm INFORMAL PATENT APPLICATION (PTO-152) which give</li> </ol>		
<ul> <li>6. ☐ CORRECTED DRAWINGS ( as "replacement sheets") must (a) ☐ including changes required by the Notice of Draftspers</li></ul>	son's Patent Drawing Review (PTO s Amendment / Comment or in the C .84(c)) should be written on the drawir he header according to 37 CFR 1.121(c) sit of BIOLOGICAL MATERIAL n	Office action of age in the front (not the back) of d).  nust be submitted. Note the
attached Examiner's comment regarding REQUIREMENT	FOR THE DEPOSIT OF BIOLOGIC	AL MATERIAL.
Attachment(s) 1. ☐ Notice of References Cited (PTO-892)	5. Notice of Informal P	atent Application (PTO-152)
2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948)	6. Interview Summary	, ,
3. ☑ Information Disclosure Statements (PTO-1449 or PTO/SB/0	Paper No./Mail Dat	ie
Paper No./Mail Date <u>9/1/04</u> 4. ☐ Examiner's Comment Regarding Requirement for Deposit	_	ent of Reasons for Allowance
of Biological Material	9.  Other	Les Les Manuelle
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#### **DETAILED ACTION**

This office action is in response to the supplemental amendment received October 18, 2004. In accordance with the amendment, claims 1, 19, and 22 have been amended; claim 9 has been canceled; and new claim 29 has been added. It is noted that minor antecedent basis problems to claims 19 and 22 have been ameliorated by the Examiner's Amendment attached herewith.

### Information Disclosure Statement

1. The prior art documents submitted by Applicant in the Information Disclosure Statements filed on September 1, 2004, have been considered and made of record (note attached copy of forms PTO-1449).

# **Priority**

2. This application claims priority to U.S. provisional application Serial No. 60/255,865, filed December 14, 2000.

## Allowable Subject Matter

3. Claims 1-8, and 10-29 are allowed. The following is an examiner's statement of reasons for allowance: the relevant prior art of record does not teach or reasonably suggest the amended limitations in independent claims 1, 19, and 22, which include "wherein the frame *defines an opening from the top surface to the bottom surface*, and the optical semiconductor component disposed in the opening". The closest prior art of record (U.S.P. No. 6,320,257 to Jayaraj et al.) teaches the previous claim limitations, but does not teach or reasonably suggest the structural limitation having the frame 122 (see Fig. 8C of Jarayaj et al. '257) with an opening from its top surface to its bottom surface, the semiconductor component disposed in said opening.

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Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

## Response to Arguments

4. Applicant's arguments, see amendment, filed October 18, 2004, with respect to the amendments to independent claims 1, 19, and 22, have been fully considered and are persuasive. The 35 U.S.C. 102 (e) and 35 U.S.C. 103 (a) rejections to claims 1-17 and 19-28 have been withdrawn. The amended limitation is allowable over the relevant prior art to Jayaraj et al. '257, as fully addressed above in the "Reasons for Allowance" section.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Daniel J Petkovsek whose telephone number is (571) 272-2355. The examiner can normally be reached on M-F 8:30-5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Rodney Bovernick can be reached on (571) 272-2344. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Daniel Petkovsek November 17, 2004

> Brian Healy Primary Examiner

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### **EXAMINER'S AMENDMENT**

1. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with Mr. Jonathan D. Baskin (Reg. #39,499) on November 18, 2004.

The application has been amended as follows ([removed], added):

19. (Currently Amended) A method for making an optical device package comprising:

- a) mounting an optical fiber to a substrate comprising an upper surface;
- b) forming a conductive trace on the upper surface of the substrate;
- c) mounting a frame to the substrate, the frame comprising a frame [upper] top surface with at least one solder pad thereon and a bottom surface, and a conductive via extending from the solder pad to the conductive trace, the frame defining an opening from the top surface to the bottom surface; and
- d) mounting an optical semiconductor component on the substrate in the opening in contact with the conductive trace and in alignment with the optical fiber.
- 22. (Currently Amended) A method for assembling an electronic circuit comprising:
  - a) providing an optical device package which comprises

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i) a substrate comprising an upper surface;

ii) an optical semiconductor component mounted to the substrate;

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- iii) an optical fiber mounted to the substrate in alignment with the optical semiconductor component;
- iv) a frame mounted to the upper surface of the substrate, the frame comprising [an upper] a top surface with a patterned array of solder balls thereon and a bottom surface, and at least one conductive pathway extending from each solder ball to the upper [major] surface of the substrate, wherein the frame defines an opening from the top surface to the bottom surface, and the optical semiconductor component is disposed in the opening; and
- v) at least one conductive trace electrically connecting the at least one conductive pathway and the optical semiconductor component;
- b) providing a circuit board comprising a patterned array of bonding pads which is a mirror image of the patterned array of solder balls on the frame;
- c) inverting and positioning the optical device package such that individual solder balls of the patterned array solder balls of the optical device package are in contact with corresponding individual bonding pads of the patterned array of bonding pads on the circuit board; and
  - d) fusing the solder balls to the corresponding bonding pads.

#### Conclusion

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iel Petkovsek November 17, 2004